

PNP Multi-Chip General Purpose Amplifier

This device is designed for general purpose amplifier and switching applications at collector currents of 10 µA to 100 mA. Sourced from Process 66.

Absolute Maximum Ratings* $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|-----------------------------------|--|-------------|-------|
| V _{CEO} | Collector-Emitter Voltage | 40 | V |
| V _{CBO} | Collector-Base Voltage | 40 | V |
| V _{EBO} | Emitter-Base Voltage | 5.0 | V |
| I _C | Collector Current - Continuous | 200 | mA |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range | -55 to +150 | °C |

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

These rating the steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
All voltages (V) and currents (A) are negative polarity for PNP transistors.

Thermal Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol | Characteristic | Max | | | Units |
|-----------------|--|------------|------------|--------------|----------------------|
| | | FFB3906 | FMB3906 | MMPQ3906 | |
| P _D | Total Device Dissipation Derate above 25°C | 300 2.4 | 700 5.6 | 1,000 8.0 | mW mW/°C |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient Effective 4 Die Each Die | 415 | 180 | 125 240 | °C/W °C/W °C/W |

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(continued)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|----------------------|---|--|----------|-----|-----|-------|
| | | | | | | |
| OFF CHAP | RACTERISTICS | | | • | • | • |
| V _{(BR)CEO} | Collector-Emitter Breakdown Voltage* | $I_{\rm C} = 1.0 \text{ mA}, I_{\rm B} = 0$ | 40 | | | V |
| V _{(BR)CBO} | Collector-Base Breakdown Voltage | $I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$ | 40 | | | V |
| V _{(BR)EBO} | Emitter-Base Breakdown Voltage | $I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$ | 5.0 | | | V |
| I _{BL} | Base Cutoff Current | $V_{CE} = 30 \text{ V}, \text{ V}_{BE} = 3.0 \text{ V}$ | | | 50 | nA |
| I _{CEX} | Collector Cutoff Current | $V_{CE} = 30 \text{ V}, \text{ V}_{BE} = 3.0 \text{ V}$ | | | 50 | nA |
| | | | | | | |
| | ACTERISTICS | | | | | |
| | | | <u> </u> | | | |
| h _{FE} | DC Current Gain * | $I_{\rm C} = 0.1 \text{ mA}, V_{\rm CE} = 1.0 \text{ V}$ | 60 40 | | | |

FFB3906 / FMB3906 / MMPQ3906

ONCH

| h _{FE} | DC Current Gain * | $I_{C} = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 60 | | |
|----------------------|--------------------------------------|---|------|------|---|
| | | MMPQ3906 | 40 | | |
| | | I _C = 1.0 mA, V _{CE} = 1.0 V | 80 | | |
| | | MMPQ3906 | 60 | | |
| | | $I_{C} = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 100 | 300 | |
| | | MMPQ3906 | 75 | | |
| | | $I_{C} = 50 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 60 | | |
| | | $I_{C} = 100 \text{ mA}, V_{CE} = 1.0 \text{ V}$ | 30 | | |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | $I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1.0 \text{ mA}$ | | 0.25 | V |
| | | $I_{C} = 50 \text{ mA}, I_{B} = 5.0 \text{ mA}$ | | 0.4 | V |
| V _{BE(sat)} | Base-Emitter Saturation Voltage | $I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1.0 \text{ mA}$ | 0.65 | 0.85 | V |
| | | $I_{C} = 50 \text{ mA}, I_{B} = 5.0 \text{ mA}$ | | 0.95 | V |

SMALL SIGNAL CHARACTERISTICS (MMPQ3906 only)

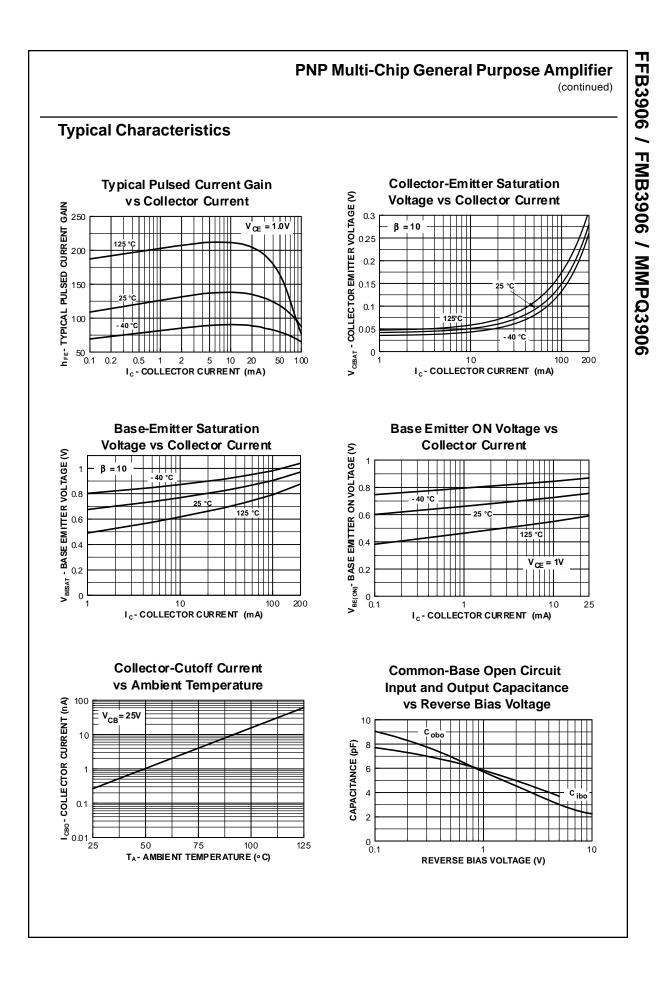
| f _T | Current Gain - Bandwidth Product | $I_{C} = 10 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz | 200 | MHz |
|------------------|----------------------------------|--|-----|-----|
| C _{obo} | Output Capacitance | $V_{CB} = 5.0 \text{ V}, I_E = 0,$ f = 140 kHz | 4.5 | pF |
| Cibo | Input Capacitance | $V_{EB} = 0.5 V, I_C = 0,$ f = 140 kHz | 10 | pF |

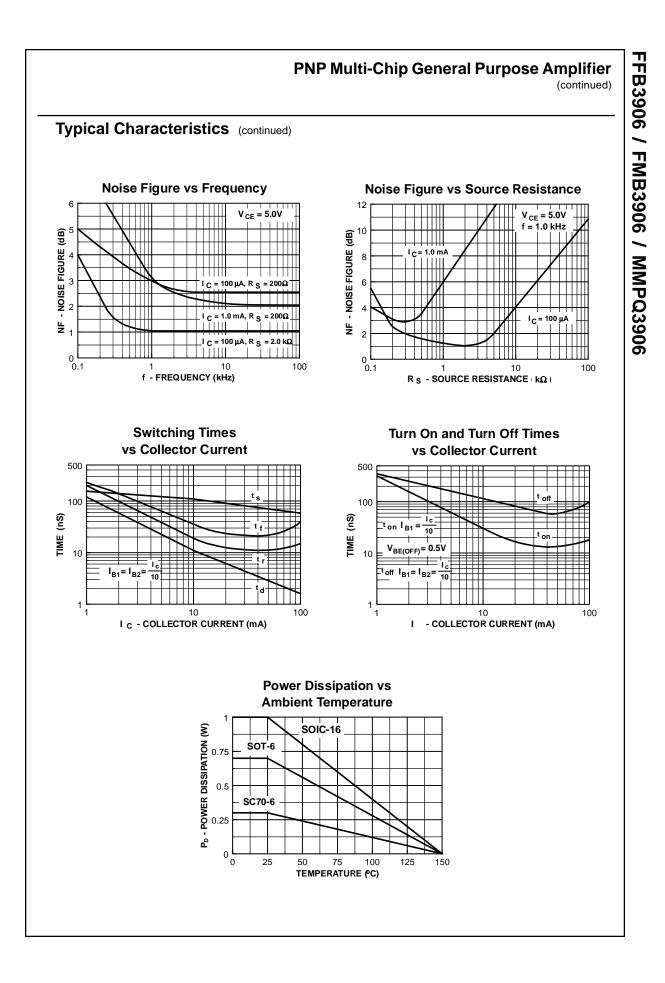
*Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

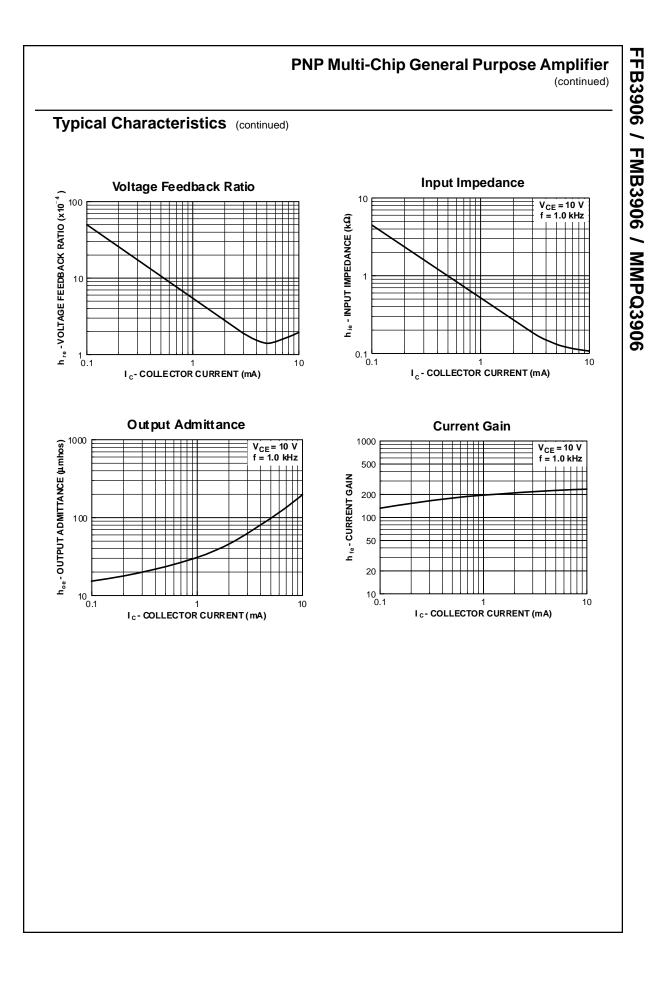
NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

Spice Model

PNP (Is=1.41f Xti=3 Eg=1.11 Vaf=18.7 Bf=180.7 Ne=1.5 Ise=0 Ikf=80m Xtb=1.5 Br=4.977 Nc=2 Isc=0 Ikr=0 Rc=2.5 Cjc=9.728p Mjc=.5776 Vjc=.75 Fc=.5 Cje=8.063p Mje=.3677 Vje=.75 Tr=33.42n Tf=179.3p Itf=.4 Vtf=4 Xtf=6 Rb=10)







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PRODUCT STATUS DEFINITIONS

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|--------------------------|---------------------------|---|
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